

PNP -3.0A -30V Middle Power Transistor

| Parameter | Value |
|------------------|-------|
| V _{CEO} | -30V |
| Ι _C | -3A |

Outline



Inner circuit

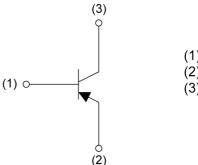
Features

- 1) Suitable for Middle Power Driver.
- 2) Low V_{CE(sat)}

V_{CE(sat)}=-200mV(Max.).

(I_C/I_B=-1A/-50mA)

- 3) High collector current.
 - I_{C} =-3A(max), I_{CP} =-6A(max)
- 4) Leadless small SMD package (HUML2020L3) Excellent thermal and electrical conductivity.



- (1) Base (2) Emitter
- (3) Collector

Application

LOW FREQUENCY AMPLIFIER

Packaging specifications

| Part No. | Package | Package size | Taping code | Reel size (mm) | Tape width (mm) | Quantity (pcs) | Marking |
|-----------|----------------------------|-----------------|----------------|-------------------|--------------------|-------------------|---------|
| 2SAR542F3 | DFN2020-3S (HUML2020L3) | 2020 | TR | 180 | 8 | 3000 | MQ |

• Absolute maximum ratings (T_a = 25°C)

| Parameter | Symbol | Values | Unit |
|------------------------------|------------------------------|-------------|------|
| Collector-base voltage | V _{CBO} | -30 | V |
| Collector-emitter voltage | V _{CEO} | -30 | V |
| Emitter-base voltage | V _{EBO} | -6 | V |
| | Ι _C | -3 | А |
| Collector current | I _{CP} *1 | -6 | Α |
| Base current | I _B | -0.5 | Α |
| Deuven die ein etien | P _D ^{*2} | 1.0 | W |
| Power dissipation | P _D *3 | 2.1 | W |
| Junction temperature | Tj | 150 | °C |
| Range of storage temperature | T _{stg} | -55 to +150 | °C |

•Electrical characteristics ($T_a = 25^{\circ}C$)

| Parameter | Symbol | Conditions | Values | | | Unit | |
|--------------------------------------|----------------------|---|--------|------|------|-------|--|
| Falameter | Symbol | Conditions | Min. | Тур. | Max. | Orint | |
| Collector-base breakdown voltage | BV_{CBO} | Ι _C = -100μΑ | -30 | - | - | V | |
| Collector-emitter breakdown voltage | BV_{CEO} | I _C = -1mA | -30 | - | - | V | |
| Emitter-base breakdown voltage | BV_{EBO} | Ι _Ε = -100μΑ | -6 | - | - | V | |
| Collector cut-off current | I _{CBO} | V _{CB} = -30V | - | - | -100 | nA | |
| Emitter cut-off current | I _{EBO} | V _{EB} = -4V | - | - | -100 | nA | |
| Collector-emitter saturation voltage | V _{CE(sat)} | I _C = -1A, I _B = -50mA | - | -90 | -200 | mV | |
| DC current gain | h _{FE} | V _{CE} = -2V, I _C = -500mA | 200 | - | 500 | - | |
| Transition frequency | f _T | V _{CE} = -10V, I _E = 100mA, f = 100MHz | - | 240 | - | MHz | |
| Output capacitance | C _{ob} | V _{CB} = -10V, I _E = 0A, f = 1MHz | - | 40 | - | pF | |
| Turn-On time | t _{on} | I _C = -2.5A, I _{B1} = -250mA, | - | 45 | - | ns | |
| Storage time | t _{stg} | I _{B2} = 250mA, V _{CC} ≃ -10V, | - | 200 | - | ns | |
| Fall time | t _f | R _L = 3.9Ω See test circuit | - | 25 | - | ns | |

*1 Pw=1ms Single Pulse

*2 Mounted on FR4 board(25.4×25.4×1.6mm, Cu PAD:645mm²).

*3 Pw=10s Mounted on FR4 board(25.4×25.4×1.6mm, Cu PAD:645mm²).

2/6

• Electrical characteristic curves($T_a = 25^{\circ}C$)

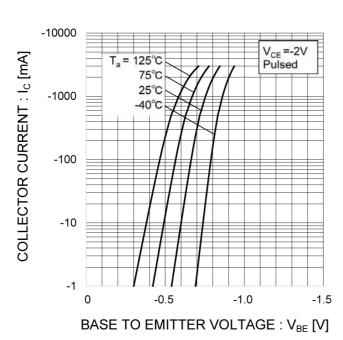


Fig.1 Grounded Emitter Propagation Characteristics

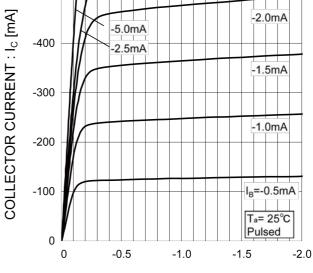


Fig.2 Typical Output Characteristics

-500

COLLECTOR TO EMITTER VOLTAGE : V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

= 125°C

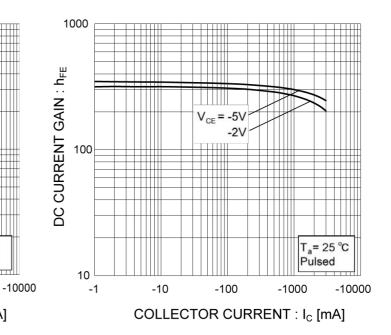
-10

-100

COLLECTOR CURRENT : Ic [mA]

75°C

25°C 40°C Fig.4 DC Current Gain vs. Collector Current (II)



DC CURRENT GAIN : hFE

1000

100

10

-1



 $V_{CE} = -2V$

Pulsed

-1000

= 50

= 20 = 10

-1000

-10000

●Electrical characteristic curves(T_a = 25°C)

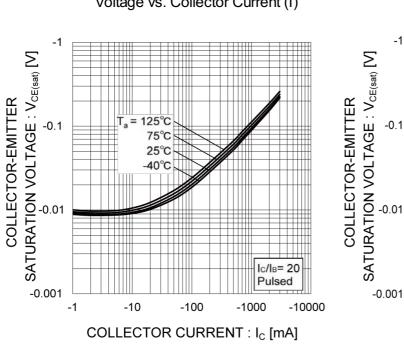
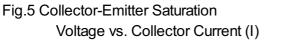


Fig.7 Base-Emitter Saturation Voltage



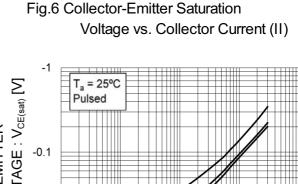


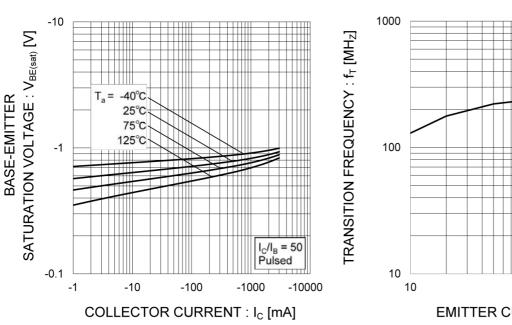
Fig.8 Gain Bandwidth Product vs. Emitter Current

-100

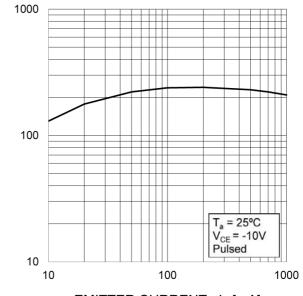
COLLECTOR CURRENT : Ic [mA]

-10

-1



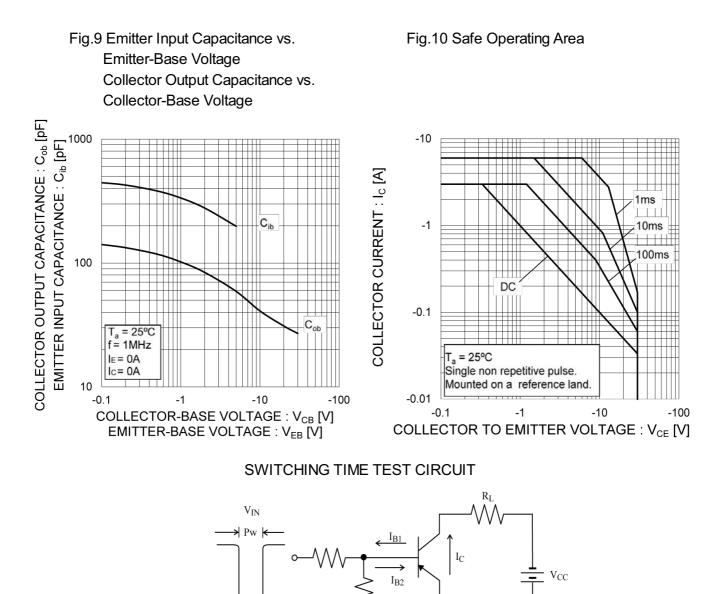
vs. Collector Current



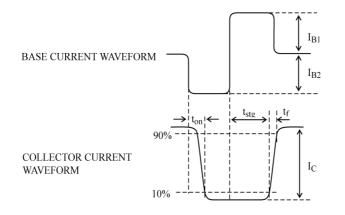
EMITTER CURRENT : IE [mA]



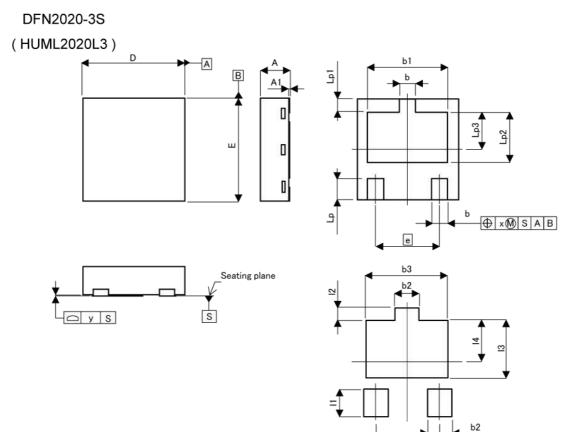
• Electrical characteristic curves(T_a = 25°C)



Pw≃50 µ s DUTY CYCLE≦1%







Pattern of terminal position areas [Not a pattern of soldering pads]

e

| DIM | MILIME | ETERS | INCHES | | |
|--------|---------------|-------|------------------|-------|--|
| | MIN | MAX | MIN | MAX | |
| A | 0.55 | 0.65 | 0.022 | 0.026 | |
| A1 | 0.00 | 0.05 | 0.000 | 0.002 | |
| b | 0.25 | 0.35 | 0.010 | 0.014 | |
| b1 | 1.40 | 1.60 | 0.055 | 0.063 | |
| D | 1.90 | 2.10 | 0.075 | 0.083 | |
| E | 1.90 | 2.10 | 0.075 | 0.083 | |
| е | 1.30 | | 0.051 | | |
| Lp | 0.35 | 0.45 | 0.014 | 0.018 | |
| Lp1 | 0.25 REF | | 0.01 REF | | |
| Lp2 | 0.90 | 1.10 | 0.035 | 0.043 | |
| Lp3 | 0.70 | 0.80 | 0.028 | 0.031 | |
| x | 97 <u>4</u> 2 | 0.10 | 121 | 0.004 | |
| у | 14 | 0.10 | (4) | 0.004 | |
| | MILIME | TERS | INC | HES | |
| DIM - | MIN | MAX | MIN | MAX | |

| DIM - | MILIME | ETERS | INCHES | | |
|-------|---------------|-------|-------------------|-------|--|
| | MIN | MAX | MIN | MAX | |
| b2 | R a ti | 0.45 | 9 4 9 | 0.018 | |
| b3 | 10=6 | 1.60 | 5 2 | 0.063 | |
| 11 | 200 | 0.55 | 5 8 | 0.022 | |
| 12 | 0.25 REF | | 0.01 | REF | |
| 13 | 11 ≦ 3 | 1.10 | 3 - 1 | 0.043 | |
| 14 | 10-0 | 0.80 | 3 .4 5 | 0.031 | |

Dimension in mm/inches



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| (Note1) Medical Equipment Classification of the Specific Applications |
|---|
|---|

| JÁPAN | USA | EU | CHINA |
|--------|----------|------------|---------|
| CLASSⅢ | CLASSⅢ | CLASS II b | CLASSII |
| CLASSⅣ | CLASSIII | CLASSⅢ | CLASSI |

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 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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